

**DECLARATION FOR PATENT APPLICATION (JOINT OR SOLE)**

(Under 37 CFR § 1.63; with Power of Attorney)

FROMMER LAWRENCE & HAUG LLP

FLH File No. ....

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention ENTITLED:

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the specification of which

is attached hereto.

was filed on **28 November 2003** as Application Serial No. **PCT/GB2003/005224**

with amendment(s) through ..... (if applicable, give dates).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

**Prior Foreign Application(s)** [list additional applications on separate page]:

<b>Number:</b>	<b>Country:</b>	<b>Filed (Day/Month/Year):</b>	<b>Priority Claimed:</b>
0227915.6	United Kingdom	29 November 2002	Yes

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application:

**Prior U.S. Application(s)** [list additional applications on separate page]:

<b>Appln. Ser. Number:</b>	<b>Filed (Day/Month/Year):</b>	<b>Status (patented, pending, abandoned):</b>
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I hereby appoint **WILLIAM S. FROMMER**, Registration No. ...., or his duly appointed associate, my attorneys, with full power of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to file continuation and divisional applications thereof, to receive the Patent, and to transact all business in the Patent and Trademark Office and in the Courts in connection therewith, and specify that all communications about the application are to be directed to the following correspondence address:

**WILLIAM S. FROMMER**, Esq.  
c/o FROMMER LAWRENCE & HAUG LLP  
745 Fifth Avenue  
New York, New York 10151

Direct all telephone calls to:  
(212) 588-0800  
to the attention of:  
**WILLIAM S. FROMMER**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**INVENTOR(S):**

Signature: ..... Date: .....

Full name of sole or first inventor: **Robert Mark Stefan Porter**

Residence: **23 Egbert Road, Winchester, Hampshire, SO23 7EB, United Kingdom**

Citizenship: **British**

Signature: ..... Date: .....

Full name of 2nd joint inventor (if any): **Ratna Rambaruth**

Residence: **216 Southway, Guildford, Surrey, GU2 8DN, United Kingdom**

Citizenship: **Dual Nationality – Mauritian and British**

Signature: ..... Date: .....

Full name of 3rd joint inventor (if any): **Simon Dominic Haynes**

Residence: **12 Chandler Road, Basingstoke, Hampshire, RG21 3JX, United Kingdom**

Citizenship: **British**

[Similarly list additional inventors on separate page]

Post Office Address(es) of inventor(s):  
[if different from residence]

Sony United Kingdom Limited  
The Heights, Brooklands,  
Weybridge, KT13 OXW, United Kingdom

Note: In order to qualify for reduced fees available to Small Entities, each inventor and any other individual or entity having rights to the invention must also sign an appropriate separate "Verified Statement (Declaration) Claiming [or Supporting a Claim by Another for] Small Entity Status" form [e.g. for Independent Inventor, Small Business Concern, Nonprofit Organization, individual Non-Inventor].

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INVENTOR(S) (cont):

Signature: ..... Date: .....

Full name of 4th joint inventor (if any): Clive Henry Gillard  
Residence: Clevelands, Hussell Lane, Medstead, Alton, Hampshire, GU34 5PF, United Kingdom

Citizenship: British

Signature: ..... Date: .....

Full name of 5th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 6th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 7th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 8th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 9th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 10th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 11th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 12th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 13th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 14th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Signature: ..... Date: .....

Full name of 15th joint inventor (if any): .....

Residence: .....

Citizenship: .....

Post Office Address(es) of inventor(s):  
[if different from residence]

Sony United Kingdom Limited  
The Heights, Brooklands,  
Weybridge, KT13 0XW, United Kingdom

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**ASSIGNMENT**

A (D&S 1-40)

**WHEREAS**, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in  
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for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

**AND WHEREAS**, SONY UNITED KINGDOM LIMITED, a United Kingdom corporation, with offices at The Heights, Brooklands, Weybridge KT13 OXW, England, (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States;

**NOW THEREFORE**, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: \_\_\_\_\_, Filing Date: \_\_\_\_\_

This assignment executed on the dates indicated below.

Name of first or sole inventor <b>Robert Mark Stefan Porter</b>	Execution date of U.S. Patent Application
Residence of first or sole inventor <b>23 Egbert Road, Winchester, Hampshire, SO23 7EB, United Kingdom</b>	
Signature of first or sole inventor	Date of this assignment

Name of second inventor <b>Ratna Rambaruth</b>	Execution date of U.S. Patent Application
Residence of second inventor <b>216 Southway, Guildford, Surrey, GU2 8DN, United Kingdom</b>	
Signature of second inventor	Date of this assignment

Name of third inventor <b>Simon Dominic Haynes</b>	Execution date of U.S. Patent Application
Residence of third inventor <b>12 Chandler Road, Basingstoke, Hampshire, RG21 3JX, United Kingdom</b>	
Signature of third inventor	Date of this assignment

Name of fourth inventor \_\_\_\_\_ Execution date of U.S. Patent Application \_\_\_\_\_

Clive Henry Gillard

**Residence of fourth inventor**

Clevelands, Hussell Lane, Medstead, Alton, Hampshire, GU34 5PF, United Kingdom

**Signature of fourth inventor** \_\_\_\_\_ **Date of this assignment** \_\_\_\_\_

Name of fifth inventor \_\_\_\_\_ Execution date of U.S. Patent Application \_\_\_\_\_

**Residence of fifth inventor**

**Signature of fifth inventor** \_\_\_\_\_ **Date of this assignment** \_\_\_\_\_

Name of sixth inventor \_\_\_\_\_ Execution date of U.S. Patent Application \_\_\_\_\_

**Residence of sixth inventor**

**Signature of sixth inventor** \_\_\_\_\_ **Date of this assignment** \_\_\_\_\_

Name of seventh inventor \_\_\_\_\_ Execution date of U.S. Patent Application \_\_\_\_\_

**Residence of seventh inventor**

**Signature of seventh inventor** \_\_\_\_\_ **Date of this assignment** \_\_\_\_\_

Name of eighth inventor \_\_\_\_\_ Execution date of U.S. Patent Application \_\_\_\_\_

Residence of eighth inventor

**Signature of eighth inventor** \_\_\_\_\_ **Date of this assignment** \_\_\_\_\_

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Reported by: SMC Data Application

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